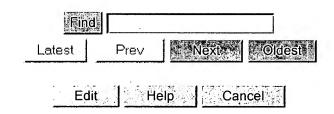
Searches for User *gverbitsky* (Count = 48644)

Queries 48595 through 48644.



S#	Upd	t Database	(
<u>S48644</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	((semiconductor or integrated circuit or c module) same (heat sink) same (overhea temperature or temperature threshold)) s hole)
<u>S48643</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	o ((62/259.2,235.1;165/104.33)![CCLS] a chip or die or microprocessor or IC or m component or electronic component) san operating temperature or temperature thr near hole)
<u>S48642</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	,
<u>S48641</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB	(62/259.2,235.1;165/104.33)![CCLS]
<u>S48640</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	062/259.2
<u>S48639</u>	<u>U</u>	PGPB	20050097911
<u>S48638</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	((semiconductor or integrated circuit or comodule) same (heat sink or electrical cor (overheat\$3 or overtemperature or opera same (cool\$4 or heat near remov\$3) and sink) and (eutectic or melt\$4)
<u>\$48637</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	, ,
<u>S48636</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	

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i.		•	•
			same (cool\$4 or heat near remov\$3) and sink)
<u>S48635</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	O((semiconductor or integrated circuit or comodule) same (heat sink or electrical cor (overheat\$3 or overtemperature or operations same (cool\$4 or heat near remov\$3)) an
<u>S48634</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	
<u>S48633</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	
<u>S48632</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	` ' '
<u>S48631</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	
<u>S48630</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	(semiconductor or integrated circuit or cl same (heat sink or electrical component of overtemperature or operating temperature
<u>S48629</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	•
<u>S48628</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	O((semiconductor or integrated circuit or c module) same (heat sink) same (overheat temperature or temperature threshold)) s
S48627	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	
<u>S48626</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	•
<u>S48625</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB	(700/1) and (downhole or borehole or w undersea or subterran\$4)
<u>S48624</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	700/1
<u>S48623</u>	<u>.</u>	USPT	6898529.pn.
<u>S48622</u>	<u>U</u>	USPT	6670605.pn.

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f			
S48621	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB	((374/140,141,4,5,137,136;702/130;62/3 [CCLS] and (heat sink or heat stor\$3 or l
<u>S48620</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB	and (downhole or borehole or wellbore o ((374/140,141,4,5,137,136;702/130;62/3 [CCLS]) and (heat sink or heat stor\$3 or
<u>S48619</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB	(374/140,141,4,5,137,136;702/130;62/3. [CCLS]
<u>S48618</u>	<u>U</u>	PGPB	(20040264543) and (maintain\$3)
<u>S48617</u>	<u>U</u>	PGPB	(20040264543) and (maintain\$3 near5 v
<u>S48616</u>	<u>U</u>	PGPB	20040264543
<u>S48615</u>	<u>U</u>	USPT	5701751.pn. and (upper tank)
<u>S48614</u>	<u>U</u>	USPT	5701751.pn. and (water)
<u>S48613</u>	<u>U</u>	USPT	5701751.pn. and (water near tank)
<u>S48612</u>	<u>U</u>	USPT	5701751.pn. and (dewar)
<u>S48611</u>	<u>U</u>	USPT	5701751.pn.
<u>S48610</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,7DBI	compar\$4 near bridge or resistance bridg
<u>S48609</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBI	temperature or reference resist\$4 or reference 7(374/\$.ccls. and (wheatstone or balanc\$3 compar\$4 near bridge or resistance bridge
<u>S48608</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBE	O(374/\$.ccls.) and (wheatstone or balancs compar\$4 near bridge or resistance bridge
<u>S48607</u>	<u>U</u>	PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD	O 374/\$.ccls.
<u>S48606</u>	<u>U</u>	USPT	3422677.pn. and (bridge)

Refine Search

Search Results -

Terms	Documents
L2 same (wellbore or downhole or bore near hole)	0

US Pre-Grant Publication Full-Text Database

US Patents Full-Text Database US OCR Full-Text Database

Database:

EPO Abstracts Database JPO Abstracts Database

Derwent World Patents Index

IBM Technical Disclosure Bulletins

Search:

19	•	
		V

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Recall Text

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Interrupt

Search History

Purge Queries Printable Copy Create Case DATE: Tuesday, May 01, 2007

<u>Set</u>		Hit	<u>Set</u>
	Query	Count	<u>Name</u>
side by			result set
	=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ		
<u>L19</u>	L2 same (wellbore or downhole or bore near hole)	0	<u>L19</u>
<u>L18</u>	L17 and (wellbore or downhole or bore near hole)	2	<u>L18</u>
<u>L17</u>	L16 and (semiconductor or integrated circuit or chip or die or microprocessor or IC or module) same (heat sink or electrical component or electronic component) same (overheat\$3 or overtemperature or operating temperature or temperature threshold)	136	<u>L17</u>
DB=	=PGPB,USPT,USOC,EPAB,JPAB; PLUR=YES; OP=ADJ		•
<u>L16</u>	(62/259.2,235.1;165/104.33)![CCLS]	3593	<u>L16</u>
DB=	=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ	•	
<u>L15</u>	62/259.2	1476	<u>L15</u>
DB=	=PGPB; PLUR=YES; OP=ADJ		
<u>L14</u>	20050097911	1	<u>L14</u>
DB=	=PGPB, USPT, USOC, EPAB, JPAB, DWPI, TDBD; PLUR = YES; OP=ADJ		

<u>L13</u>	L11 and (eutectic or melt\$4)	65	<u>L13</u>
<u>L12</u>	L11 and (eutectic)	31	<u>L12</u>
<u>L11</u>	L10 and (heat stor\$4 or heat sink)	231	<u>L11</u>
<u>L10</u>	L6 and (heat exchang\$3)	257	<u>L10</u>
<u>L9</u>	L6 and (heat near exhang\$4)	0	<u>L9</u>
<u>L8</u>	L6 and (eutectic)	101	<u>L8</u>
<u>L7</u>	L6 and (wellbore or downhole or bore near hole)	5	<u>L7</u>
<u>L6</u>	L5 same (cool\$4 or heat near remov\$3)	976	<u>L6</u>
<u>L5</u>	(semiconductor or integrated circuit or chip or die or microprocessor or IC or module) same (heat sink or electrical component or electronic component) same (overheat\$3 or overtemperature or operating temperature or temperature threshold)	2247	<u>L5</u>
<u>L4</u>	L3 and (eutectic)	71	<u>L4</u>
<u>L3</u>	L2 same (cool\$4 or heat near remov\$3)	780	<u>L3</u>
<u>L2</u>	(semiconductor or integrated circuit or chip or die or microprocessor or IC or module) same (heat sink) same (overheat\$3 or overtemperature or operating temperature or temperature threshold)	1669	<u>L2</u>
<u>L1</u>	(semiconductor or integrated circuit or chip or die or microprocessor or IC or module) same (heat sink)	40196	<u>L1</u>

END OF SEARCH HISTORY